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INFORMATION DISCLOSURE STATEMENT BY APPLICANT	Application Number	10/789,042		
(Use as many sheets as necessary)	Filing Date	February 27, 2004		
	First Named Inventor	Ahn, Kie		
	Group Art Unit	2815		
	Examiner Name	Landau, Matthew		
Sheet 1 of 4	Attorney Docket No: 1	303.050US2		

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	Group Art Unit	2815	
	Examiner Name	Landau, Matthew	
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